

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
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CORRESPONDENCE DATA															
Fax Number:	(703)413-2220														
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<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>															
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Address Line 4:	ALEXANDRIA, VIRGINIA 22314														
ATTORNEY DOCKET NUMBER:	429695US20RD														
NAME OF SUBMITTER:	ARIELLE ADAMS														

Signature:	/Arielle Adams/
Date:	02/07/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).
<p>Total Attachments: 6 source=429695USASN#page1.tif source=429695USASN#page2.tif source=429695USASN#page3.tif source=429695USASN#page4.tif source=429695USASN#page5.tif source=429695USASN#page6.tif</p>	

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	NITRIDE SEMICONDUCTOR WAFER, NITRIDE SEMICONDUCTOR ELEMENT, AND METHOD FOR MANUFACTURING NITRIDE SEMICONDUCTOR WAFER
As the below named inventor, I hereby declare that: This declaration <input checked="" type="checkbox"/> The attached application, or is directed to: <input type="checkbox"/> United States application or PCT international application number _____ filed on _____ The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. WHEREAS, <u>Kabushiki Kaisha Toshiba</u> (hereinafter referred to as "ASSIGNEE") having places of business at: <u>1-1, Shibaura 1-chome, Minato-ku, Tokyo, Japan</u> , is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries; NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the International Convention and other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof. I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made. Further, I agree that I will communicate to said ASSIGNEE or its (his) representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	
LEGAL NAME OF INVENTOR	
Inventor: <u>Kei KANEKO</u>	Date: <u>January 22, 2014</u>
Signature: <u>Kei Kaneko</u>	

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, L.L.P.
ATTORNEYS AT LAW
1940 DUKE STREET
ALEXANDRIA, VIRGINIA 22314

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LEGAL NAME OF INVENTOR	
Inventor: <u>Mitsuhiro KUSHIBE</u>	Date: <u>Jan. 22, 2014</u>
Signature: <u>Mitsuhiro Kushibe</u>	

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LEGAL NAME OF INVENTOR	
Inventor: <u>Hiroshi KATSUNO</u>	Date: <u>Jan. 21, 2014</u>
Signature: <u>Hiroshi Katsuno</u>	

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LEGAL NAME OF INVENTOR	
Inventor: <u>Shinji YAMADA</u>	Date: <u>Jan. 24, 2014</u>
Signature: <u>Shinji Yamada</u>	

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LEGAL NAME OF INVENTOR	
Inventor: <u>Jumpei TAJIMA</u>	Date: <u>January 22, 2014</u>
Signature: <u>Jumpei Tajima</u>	

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Inventor: <u>Yasuo OHBA</u>	Date: <u>Jan. 29, 2014</u>
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